



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
20V	0.4Ω @ V _{GS} = 4.5V	1.3A
	0.5Ω @ V _{GS} = 2.5V	1.2A
	0.7Ω @ V _{GS} = 1.8V	1.0A

Features and Benefits

- Footprint of just 0.6mm² Thirteen Times Smaller than SOT23
- 0.4mm Profile Ideal for Low Profile Applications
- Low Gate Threshold Voltage
- Fast Switching Speed
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2451UFB4Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Load Switch

Mechanical Data

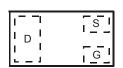
- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.001 grams (Approximate)

X2-DFN1006-3

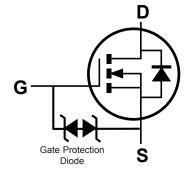




Bottom View



Top View Internal Schematic



Equivalent Circuit

Ordering Information (Note 4)

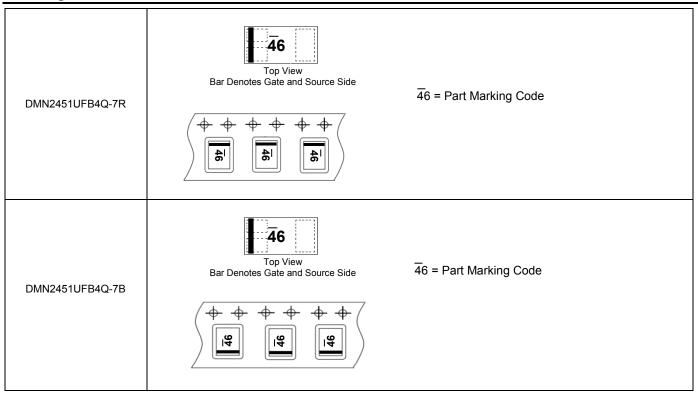
Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Tape Pitch (mm)	Packaging
DMN2451UFB4Q-7B	46	7	8	2	10,000/Reel
DMN2451UFB4Q-7R	46	7	8	4	3,000/Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information





Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V_{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	l n	1.3 1.0	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	3	Α

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	0.66	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	189	°C/W
Total Power Dissipation (Note 6)	P _D	1.1	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	113	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

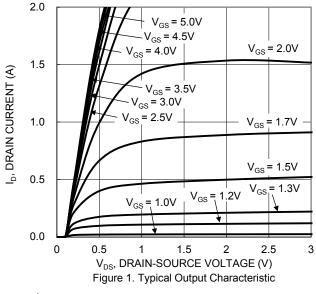
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	V _{GS} = 0V, I _D = 250μA	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	100	nA	V _{DS} = 20V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±1.0	μA	V _{GS} = ±4.5V, V _{DS} = 0V	
ON CHARACTERISTICS (Note 7)						•	
Gate Threshold Voltage	V _{GS(TH)}	0.5	_	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
		_	0.26	0.4	Ω	V _{GS} = 4.5V, I _D = 600mA	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	0.35	0.5		V _{GS} = 2.5V, I _D = 500mA	
		_	0.5	0.7		V _{GS} = 1.8V, I _D = 350mA	
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	V _{GS} = 0V, I _S = 150mA	
DYNAMIC CHARACTERISTICS (Note 8)	•					•	
Input Capacitance	C _{iss}	_	32	_	pF		
Output Capacitance	C _{oss}	_	5.5	_	pF	$V_{DS} = 16V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	3.7	_	pF	1 - 1.000112	
Gate Resistance	Rg	_	86	_	Ω	V _{DS} = 0V, V _{GS} = 0V	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	3.4	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	_	6.4	_	nC	V _{DS} = 10V,	
Gate-Source Charge	Q _{gs}	_	0.4	_	nC	I _D = 250mA	
Gate-Drain Charge	Q _{gd}	_	1.3	_	nC	1	
Turn-On Delay Time	t _{D(ON)}	_	5.5	_	ns		
Turn-On Rise Time	t _R	_	2.9	_	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	11	_	ns	$R_L = 47\Omega, R_g = 10\Omega,$ $I_D = 200 \text{mA}$	
Turn-Off Fall Time	t _F	_	12	_	ns	- ID - ZUUIIIA	

Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 25mm X 25mm square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.





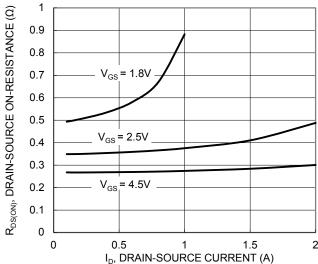


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

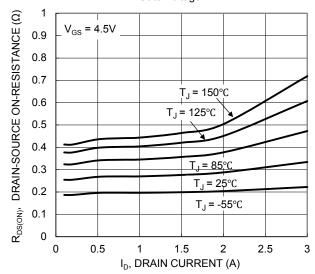
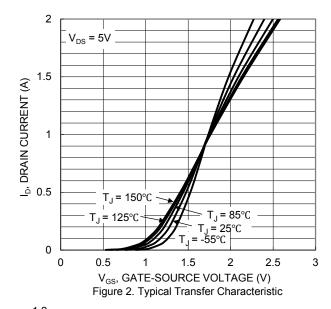
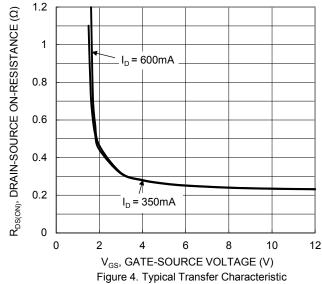


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





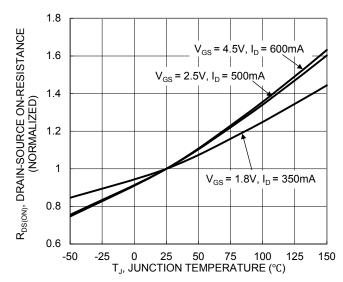


Figure 6. On-Resistance Variation with Junction Temperature



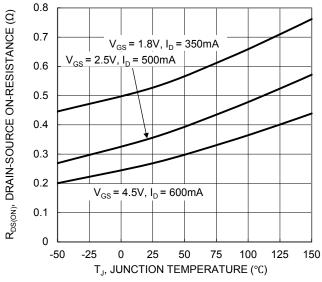


Figure 7. On-Resistance Variation with Junction Temperature

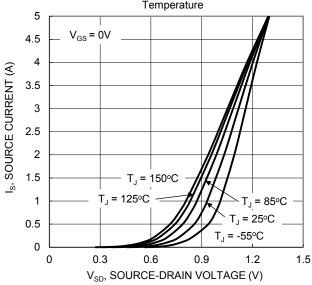


Figure 9. Diode Forward Voltage vs. Current

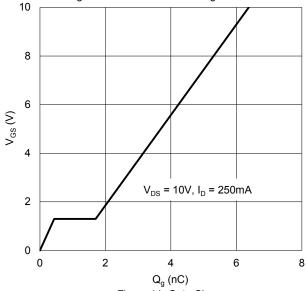


Figure 11. Gate Charge

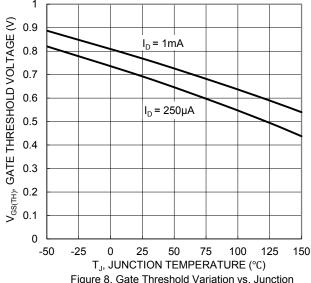
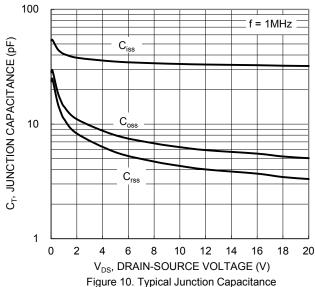


Figure 8. Gate Threshold Variation vs. Junction Temperature



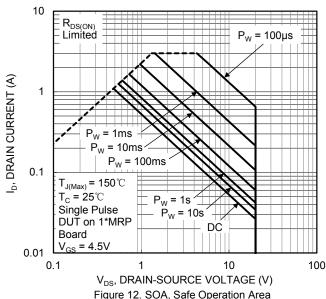


Figure 12. SOA, Safe Operation Area



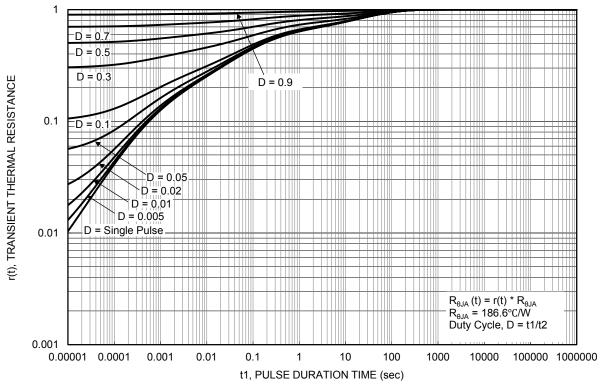


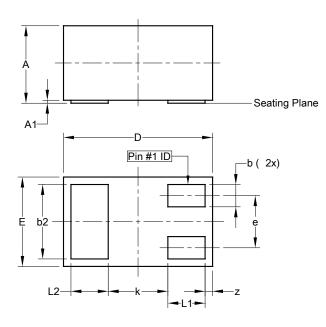
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3

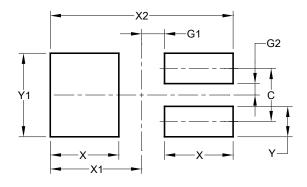


V0 DEN4000 0						
X2-DFN1006-3						
Dim	Min	Max	Тур			
Α		0.40	_			
A 1	0.00	0.05	0.03			
b	0.10	0.20	0.15			
b2	0.45	0.55	0.50			
D	0.95	1.05	1.00			
Е	0.55	0.65	0.60			
е	-	-	0.35			
L1	0.20	0.30	0.25			
L2	0.20	0.30	0.25			
k	-	-	0.40			
Z	0.02	0.08	0.05			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3



Dimensions	Value (in mm)			
С	0.350			
G1	0.150			
G2	0.075			
X	0.450			
X1	0.600			
X2	1.200			
Υ	0.200			
Y1	0.550			



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